



Material Content Data Sheet



Halogen-Free

Sales Product Name	SPD06N60C3	Issued	13. May 2021
MA#	MA001966286		
Package	PG-TO252-3-341	Weight*	389.21 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.096	1.05	1.05	10523	10523
leadframe	inorganic material	phosphorus	7723-14-0	0.069	0.02		177	
	non noble metal	iron	7439-89-6	0.229	0.06		589	
	non noble metal	copper	7440-50-8	228.946	58.82	58.90	588236	589002
wire	non noble metal	aluminium	7429-90-5	0.418	0.11	0.11	1075	1075
encapsulation	organic material	carbon black	1333-86-4	0.386	0.10		991	
	plastics	epoxy resin	-	11.696	3.01		30051	
	inorganic material	silicondioxide	60676-86-0	116.446	29.92	33.03	299188	330230
leadfinish	non noble metal	tin	7440-31-5	3.740	0.96	0.96	9609	9609
plating	non noble metal	nickel	7440-02-0	0.509	0.13	0.13	1307	1307
solder	non noble metal	tin	7440-31-5	0.069	0.02		178	
	noble metal	silver	7440-22-4	0.087	0.02		223	
	non noble metal	lead	7439-92-1	3.315	0.85	0.89	8516	8917
heatspreader	inorganic material	phosphorus	7723-14-0	0.006			15	
	non noble metal	iron	7439-89-6	0.019			49	
	non noble metal	copper	7440-50-8	19.177	4.93	4.93	49273	49337
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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